PCN Number:	20170713		000		PCN Date:		July 26, 2017		
Title: Datasheet for BQ21040									
Customer Contact:		Manager				Dept:		Quality Services	
Proposed 1 st Ship Da	r 26, 2017								
Change Type:									
Assembly Site			Design				Wafer Bump Site		
Assembly Process			□ Data Sheet				Wafer Bump Material		
Assembly Materials			Part number change				Wafer Bump Process		
Mechanical Specification			Test Site				Wafer	Fab Site	
Packing/Shipping/Labeling			Test Process					Fab Materials	
							Wafer Fab Process		
Notification Details									
Description of Change:									
Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below.									
TEXAS									
Instruments						bq21040			
SLUSCE2B – APRIL 2016–REVISED MAY 2017									
Changes from Revision A (April 2016) to Revision B									
Changed MIN and MAX values in the Electrical Characteristics table, Changed MIN and MAX values for Fast									
charge current factor, KISET 1									
Added Receiving Notification of Documentation Updates section									
The datasheet number	e changi				Characa Tar				
Device Family			Change F					Change To:	
BQ21040 SLUSCE2A SLUSCE2B							SLUSCEZB		
These changes may be reviewed at the datasheet links provided.									
http://www.ti.com/product/BQ21040									
Reason for Change:									
To more accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
Electrical specification performance changes as indicated above.									
Changes to product identification resulting from this PCN:									
None.									
Product Affected:									
BQ21040DBVR	BQ21040DBVT								

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com